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<b>TRANSMITTAL FORM</b>  (to be used for all correspondence after initial filing)	Application Number	10/549,401
	Filing Date	September 13, 2005
	First Named Inventor	Brian J. Daniels
	Art Unit	Unknown
	Examiner Name	Unknown
Total Number of Pages in This Submission	Attorney Docket Number	H0006041.70974-US

ENCLOSURES (Check all that apply)		
<input type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Fee Attached <input type="checkbox"/> Amendment/Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input checked="" type="checkbox"/> Information Disclosure Statement  <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Reply to Missing Parts/ Incomplete Application <input type="checkbox"/> Reply to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Drawing(s) <input type="checkbox"/> Licensing-related Papers  <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation <input type="checkbox"/> Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s) _____ <input type="checkbox"/> Landscape Table on CD	<input type="checkbox"/> After Allowance Communication to TC <input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences <input type="checkbox"/> Appeal Communication to TC (Appeal Notice, Brief, Reply Brief) <input type="checkbox"/> Proprietary Information <input type="checkbox"/> Status Letter <input checked="" type="checkbox"/> Other Enclosure(s) (please identify below): 2 Return Receipt Postcards; Copy of 48 cited references
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SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT		
Firm Name	Wells St. John P.S.	
Signature	<i>Jennifer J. Taylor</i>	
Printed name	Jennifer J. Taylor, Ph.D.	
Date	June 12, 2006	Reg. No. 48,711

CERTIFICATE OF TRANSMISSION/MAILING	
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EV850819276

Inventor: Brian J. Daniels et al.

Title: Copper-Containing PVD Targets and Methods for Their Manufacture

Assignee: Honeywell International Inc.

**INFORMATION DISCLOSURE STATEMENT**

References – See Attached Form PTO-1449

The attached form PTO-1449 is submitted in compliance with 37 CFR §1.56. No admission is made regarding whether any of the submitted references is prior art. Copies of the references are attached.

Respectfully submitted,

Dated: June 12, 2006

By: Jennifer J. Taylor  
Jennifer J. Taylor, Ph.D.  
Reg. No. 48,711

Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. H0006041.70974 US		SERIAL NO. 10/549,401	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)				APPLICANT Brian J. Daniels et al.		FILING DATE September 13, 2005	
				GROUP <del>Unknown</del> 1793			
U.S. PATENT DOCUMENTS							
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/S.I./	AI	4,629,859	12-1986	Reddy			
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/S.I./	AM	0335383 A2	10-1989	EPO			
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						Yes	No	
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							Yes	No
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LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)					APPLICANT Brian J. Daniels et al.			
					FILING DATE September 13, 2005		GROUP <del>UNKNOWN</del> 1793	
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		FILING DATE September 13, 2005	GROUP <del>Unknown</del> 1793

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/S.I./	AA	6,165,607	12-2000	Yamanobe et al.			
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	AE							
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	AI							
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